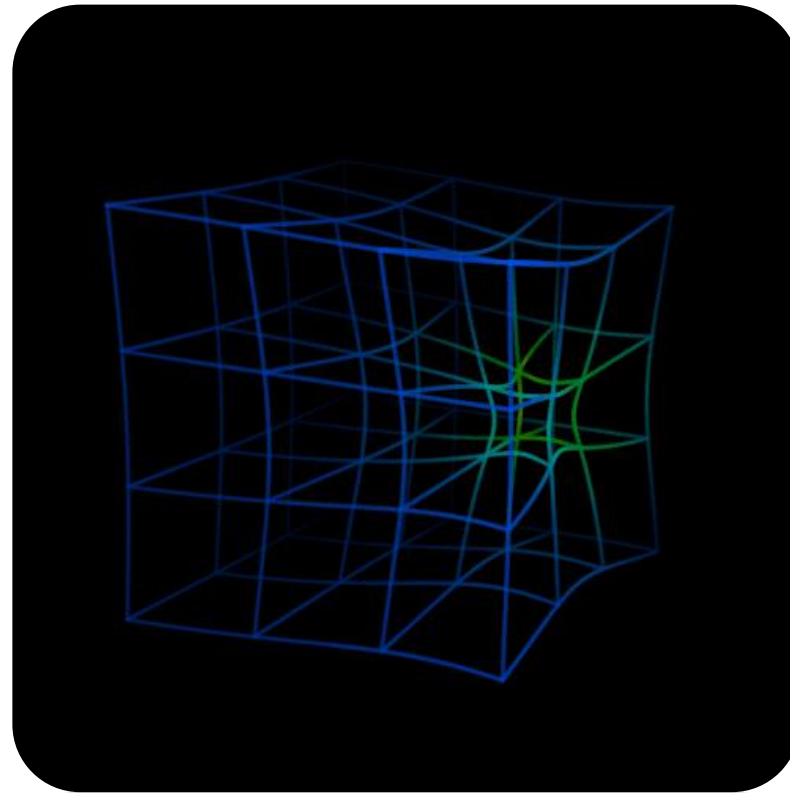
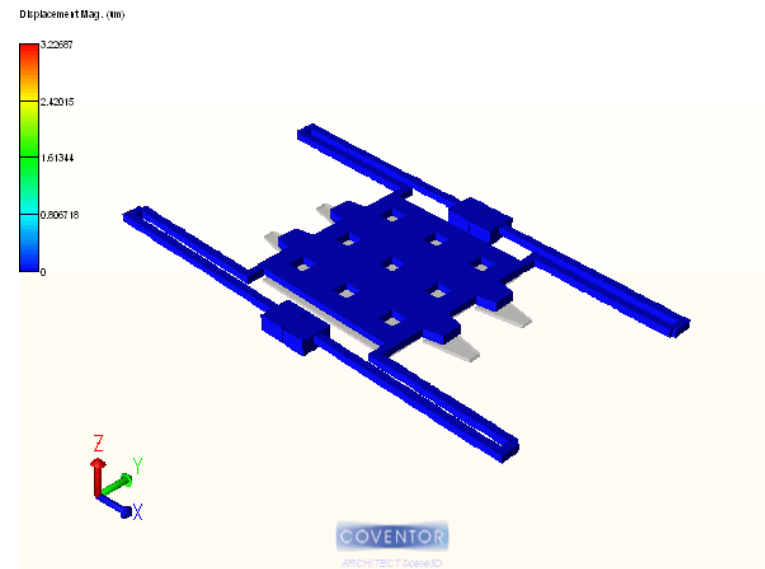
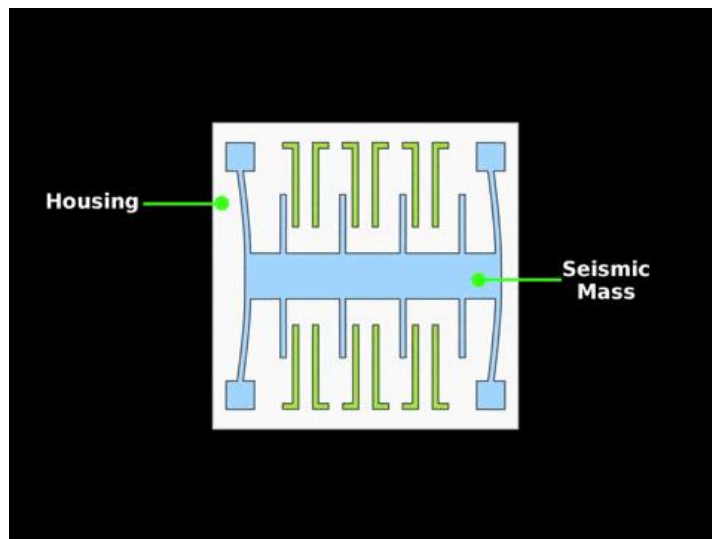


MICROMECHANICS



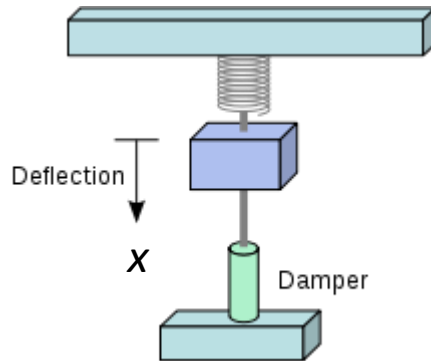
Damping: Pro and Contra

- In MEMS devices we always have **MOVING PARTS**
- When considering e.g. an **accelerometer** it is obvious that the movement should be **DEFINED**
- This means that two side effects should be avoided:
 1. **Massive damping** which reduces both, the **sensitivity** (image an accelerometer in honey) and the **overall efficiency** (power losses)
 2. **Over-oscillations** as **wrong signals** could appear (here damping would be good)
- Both demands, however, are **opposite** (damping vs. no damping) and the solution lies somewhere in between depending on the application ... **so we have to have a closer look**



Damping: General

- We start with a simple, **damped oscillating mass**



$$F = m \left(\frac{d^2x}{dt^2} \right) + c \left(\frac{dx}{dt} \right) + kx$$

x ... displacement
 c ... damping coefficient
 k ... spring constant

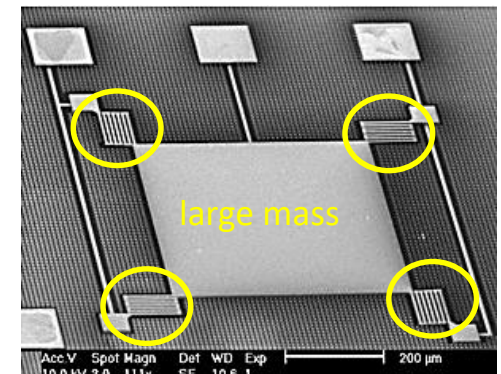
- For an ideal case, the **damping is zero** $\rightarrow c \left(\frac{dx}{dt} \right) = 0$

- With $F = 0$ it follows:

$$x = -\frac{ma}{k}$$

- Design Rule:** **high sensitivity (large x)** follows if

- The **mass is large** (which explains the large proof-masses)
- Spring constants are low** (which explains the small connection parts)



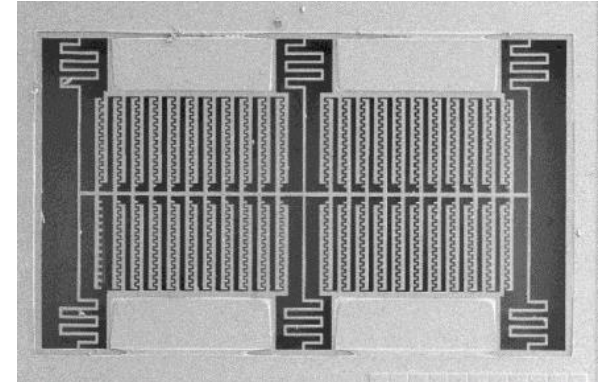
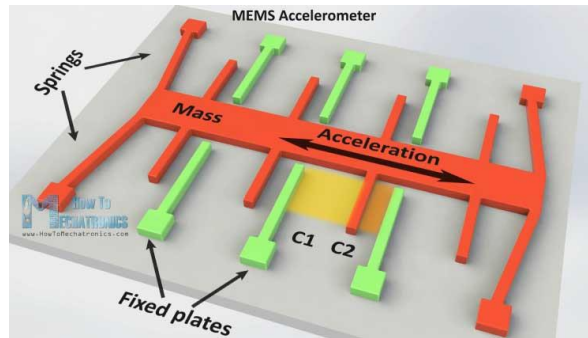
Sensitivity: Capacitive Accelerometer

- Here we transfer the displacement Δx into a capacity change ΔC (transducing mechanism)

$$x = -\frac{ma}{k}$$

&

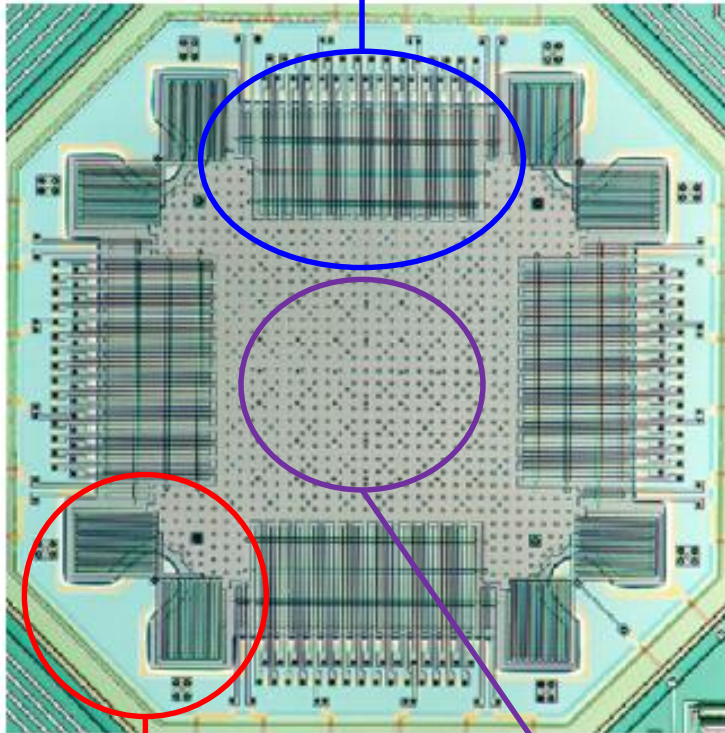
$$C = \frac{\epsilon A}{d}$$



- From the latter equation we see that highest C changes are obtained if we use:
 - Large interface areas
 - Small interface distances d
- Taking the first equation into account as well we see that for smallest d's we again need :
 - Large displacements x ...
 - ... which require large masses and soft springs (small k)
- Additional Design Rules:**
 1. Large interface areas (explaining multiple fingers with high structures)
 2. Strong distance changes equivalent to large displacements (high mass, soft springs)

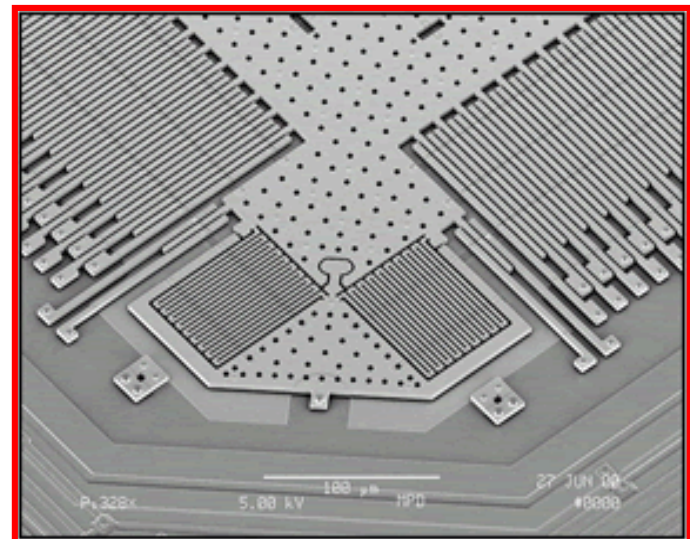
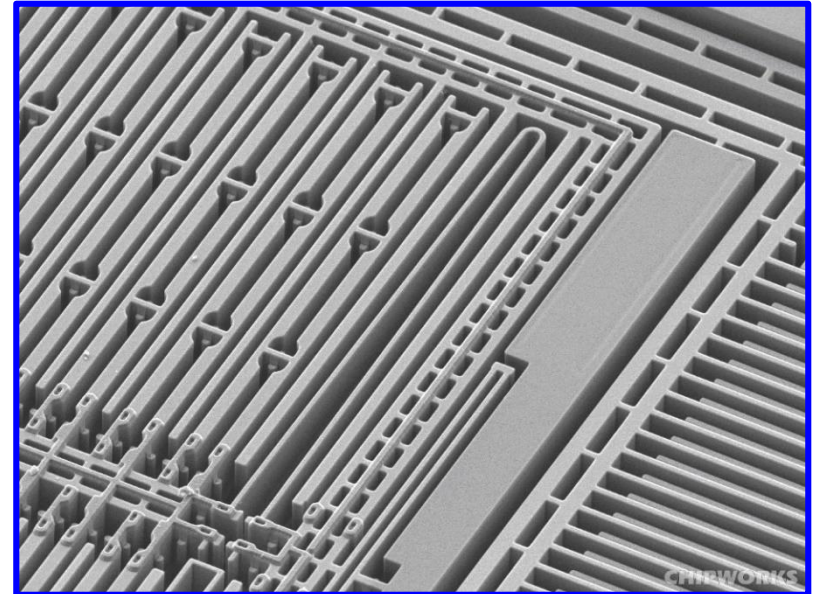
Sensitivity: Design Rules

large area interfaces (detection)



soft springs
(high sensitivity)

high masses
(high sensitivity)



Sensitivity: Gyroscopes General

- The responsible force to **measure the angular rate** in **gyroscopes** is the **Coriolis Force**

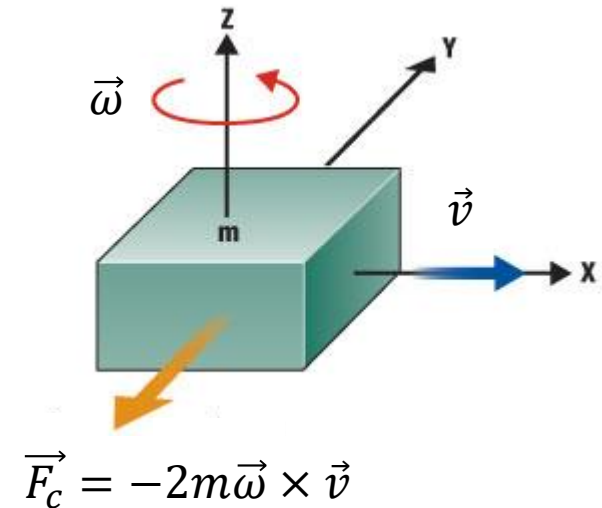
- $$\vec{F}_c = -2m\vec{\omega} \times \vec{v}$$

m ... mass

$\vec{\omega}$... angular velocity

\vec{v} ... linear velocity

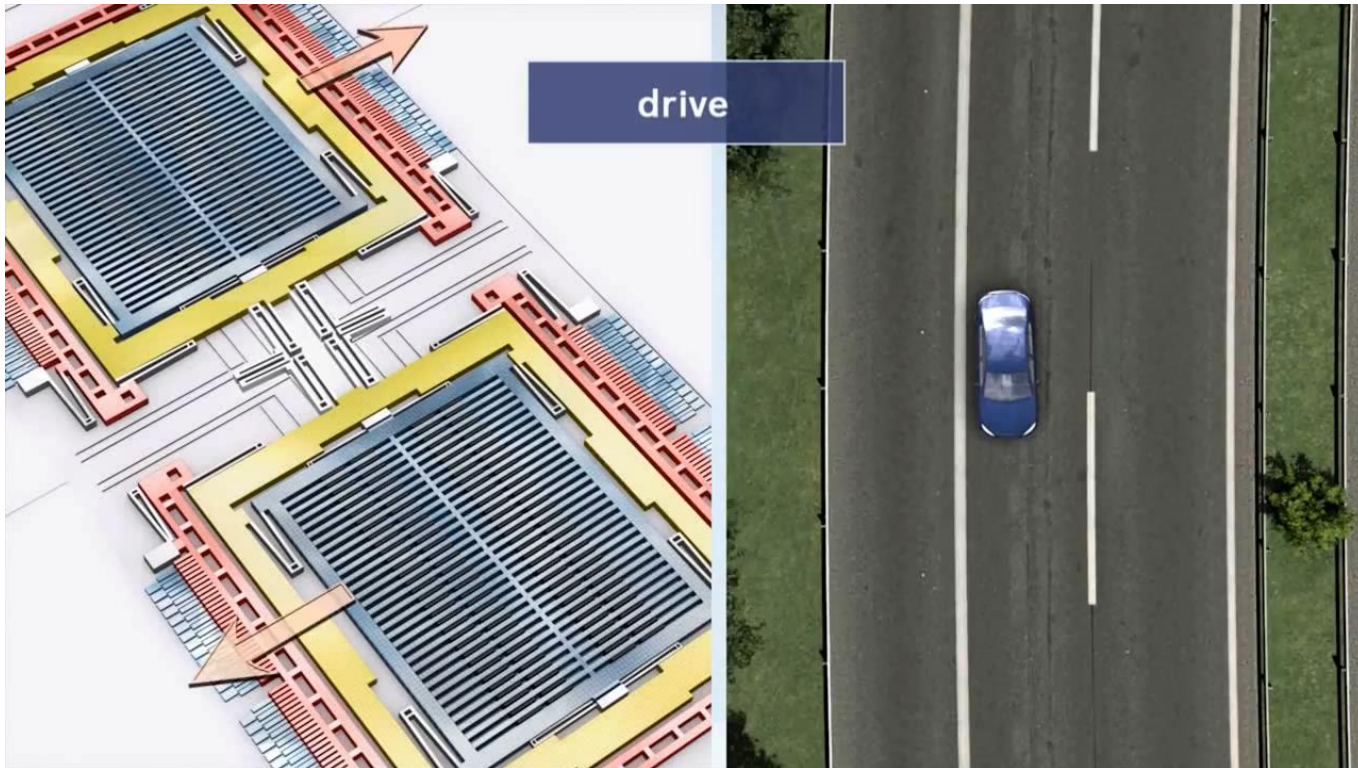
- This means that for an **arising angular velocity** in a **moving system** a force evolves **perpendicular on the $\vec{v}, \vec{\omega}$ plane** (and negative in direction)



- And we can **immediately derive the requirement for highest sensitivity**:
 - Large mass** (as before)
 - High initial velocity \vec{v}** (which finally explains the high frequency operation)

Linear Gyroscopes

- However, we have seen that most of the modern Gyroscopes use oscillation instead of rotation



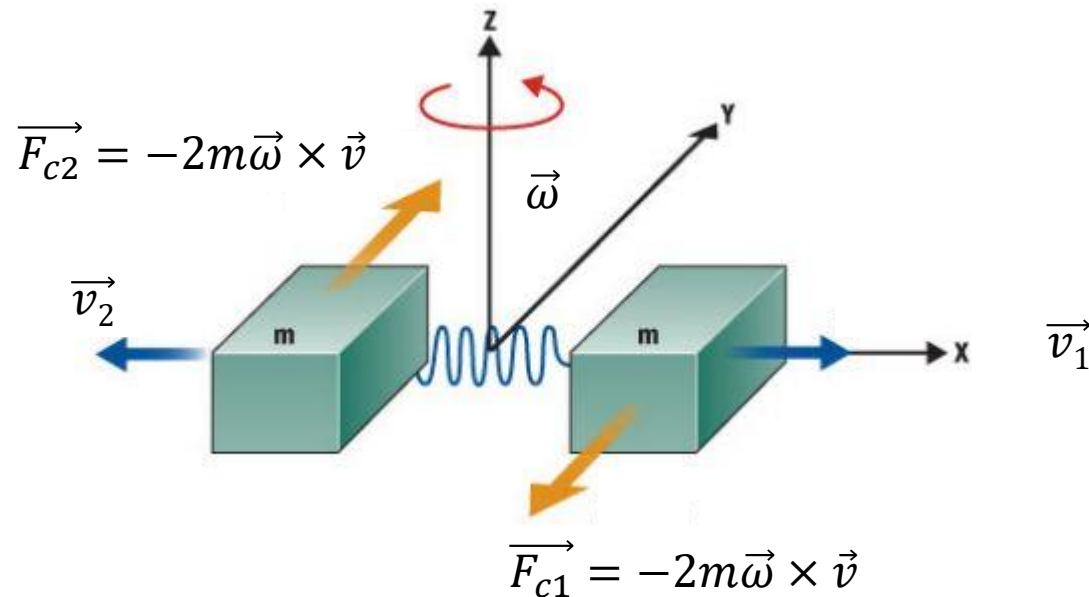
Linear Gyroscopes: Detail

- However, we have seen that most of the modern Gyroscopes use oscillation instead of rotation



Sensitivity: Gyroscopes Rotation vs. Oscillation

- Is that in conflict with the before discussed formalism?
- The trick is that we use a **differential approach** which is easier in detection
- This means that **two masses are oscillated linearly but in OPOSITE directions**
- What is detected is the capacity change DC which maximizes due to the differential operation



$$\Delta C = |\Delta C_1 - \Delta C_2|$$

Scalability – WHY and HOW?

We introduce a factor S which describes the scaling:

- $L_{\text{new}} = S * L_{\text{old}}$
- $W_{\text{new}} = S * W_{\text{old}}$
- $H_{\text{new}} = S * H_{\text{old}}$

For the right hand case it means that we have a scaling factor of $1/10$ or 0.1

How do some quantities scale with?

Lengths (s):

- Dimensions l , w , h scale via S^1

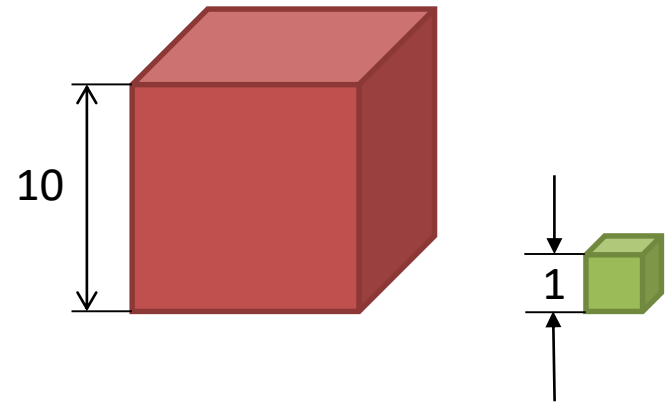
Surface (A):

- $A = L_{\text{new}} * L_{\text{new}} = L_{\text{old}} * S * L_{\text{old}} * S = L_{\text{old}} * L_{\text{old}} * S^2$
- It follows that **A** scales with S^2

Volume (V):

- $V = L_{\text{new}}^3 = L_{\text{old}}^3 * S^3$
- Hence, **V** scales via S^3

- First derived quantity Surface to Volume $\rightarrow S/V = \frac{6 * L_{\text{old}}^2 * S^2}{L_{\text{old}}^3 * S^3} = S/V_{\text{old}} * \frac{1}{S} \rightarrow$ for $S = 1/10 \rightarrow \times 10!$



Scalability: More Quantities and an Example

Further quantities of interest:

- Mass (weight) $\rightarrow m = \rho * V \quad \rightarrow m \sim L^3 \rightarrow \sim S^3$
- Moment of inertia $\rightarrow I \sim m * R^2 = S^3 * S^2 \quad \rightarrow \sim S^5$
- Torque $\rightarrow \tau \sim R \times m * g \sim S * S^3 \quad \rightarrow \sim S^4$

Lets have a look on the [water bug](#) and [why he can move on water](#) (γ_{H_2O} is 72 mN/m)

Real person

- Mass: 50 kg
- Weight: $F = m.g = 50 * 9.8 = 490$ N
- Required **perimeter to “float”**: $L = F / (2.\gamma) = 490 / (2.72.10^{-3}) = 3403$ m (☹)



Water bug ($S = 1/1000$)

- Mass: $m_{HUMAN} * S^3 = m_{HUMAN} * (10^{-3})^3 = m_{HUMAN} * 10^{-6} = 50 * 10^{-6}$ kg
- Weight: $50 * 10^{-6} * 9.8 = 4.9 * 10^{-7}$ N
- Required **perimeter to “float”**: $4.9 * 10^{-7} / (2.72.10^{-3}) = 3.4$ μ m (☺)



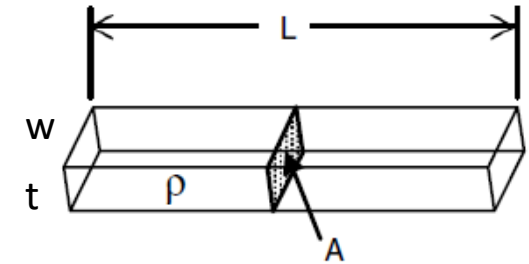
Scalability: Other Quantities

Electric resistance - R:

$$R = \frac{\rho L}{A} = \frac{\rho L}{wt} \propto \frac{1}{S}$$

ρ ... electrical resistivity

- Smaller dimensions increase R

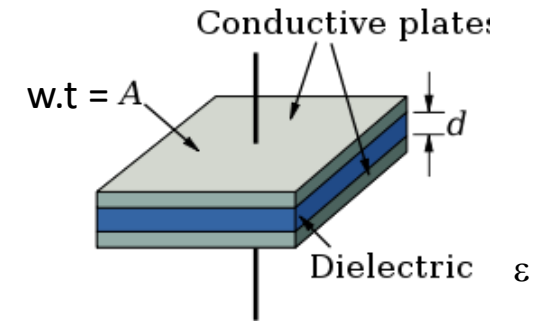


Electric capacitance – C:

$$C = \frac{\epsilon_0 \epsilon_r A}{d} = \frac{\epsilon wt}{d} \propto S$$

ϵ_0 ... electric constant
 ϵ_r ... dielectric constant (rel. permittivity)

- Smaller dimensions decrease C (area related)

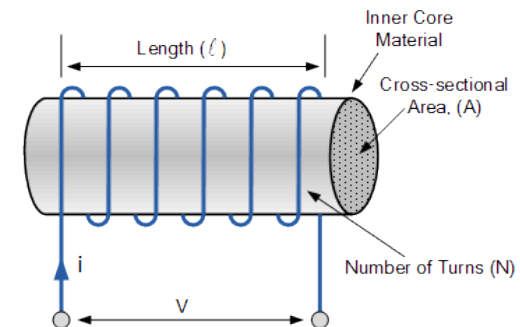


Electric Inductance – L:

$$L = \frac{\mu N^2 A}{l} = \frac{\mu N^2 wt}{l} \propto S$$

μ_0 ... magnetic constant
 μ_r ... relative permeability
 N ... number of windings
 l ... coil length

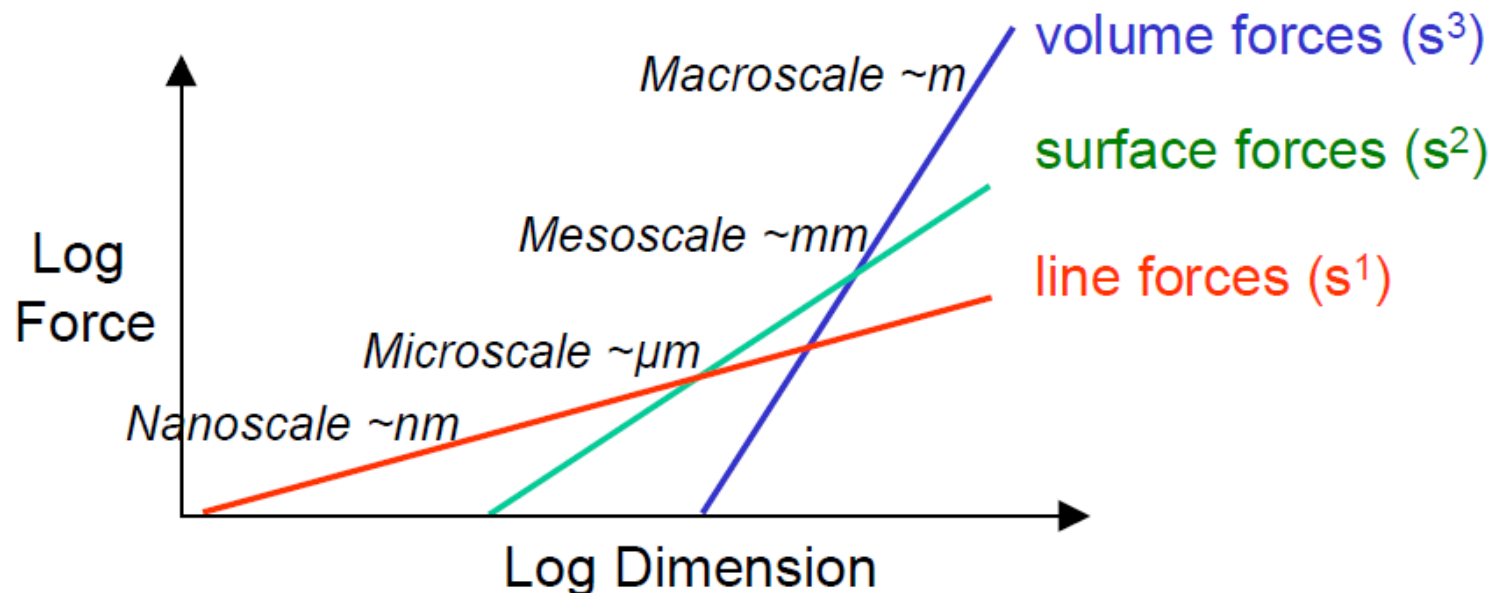
- Smaller dimensions decrease L



Force Behaviour During Downscaling

Considering MEMS relevant forces in general, we can summarize

- Surface tension $\rightarrow s^1$
- Electrostatic 2D, pressure $\rightarrow s^2$
- Magnetic 2D, gravitational $\rightarrow s^3$
- Magnetic 3D $\rightarrow s^4$
- That means that all forces can be downscaled but some of them get VERY small for VERY small scales which is why the micron-scale is fine for most applications (NEMS can get complicated)



Scalability: Stiffness

In many cases MEMS work with resonant systems ... lets have a closer look on simple systems

Single beam stiffness (one side fixed Euler buckling):

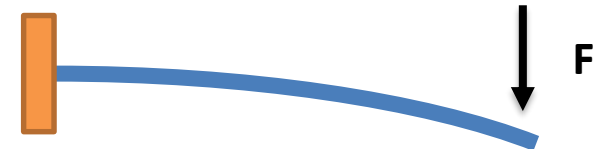
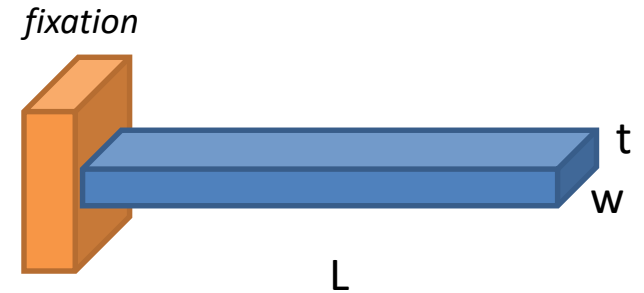
$$k_{bending} \propto \frac{EI}{L^3} \propto \frac{Ewt^3}{L^3} \propto S$$

E ... Young's modulus
 I ... second moment of area

- Which means that smaller dimensions makes the beam softer

$$k_{axial} \propto \frac{EA}{L} \propto \frac{Ewt}{L} \propto S$$

- Which means that smaller dimensions makes the beam softer



Scalability: Natural Frequencies

As a result, the natural frequencies f_n change as follows:

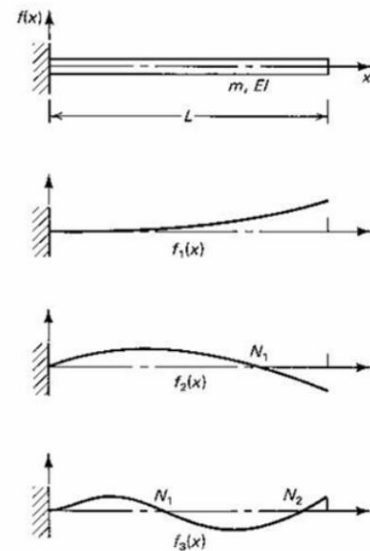
$$k \propto \frac{Ewt^3}{L^3} \propto S \quad \rightarrow \quad f_n = n \frac{1}{2\pi} \sqrt{\frac{k}{m}} \propto \sqrt{\frac{k}{m}} \propto \sqrt{\frac{S}{S^3}} \propto \frac{1}{S}$$

- This means that e.g. a reduction by a factor 10 means an increase by a factor of 10!
- However, we here always assumed a HOMOGENEOUS downscaling of ALL dimensions!
- If we change e.g. only the width it follows

$$m = \rho V = \rho Ltw \propto w \propto S \quad \rightarrow \quad f_n = \frac{1}{2\pi} \sqrt{\frac{k}{m}} \propto \sqrt{\frac{k}{m}} \propto \sqrt{\frac{Sk_{old}}{Sm_{old}}} \propto \sqrt{\frac{S}{S}} = 1$$

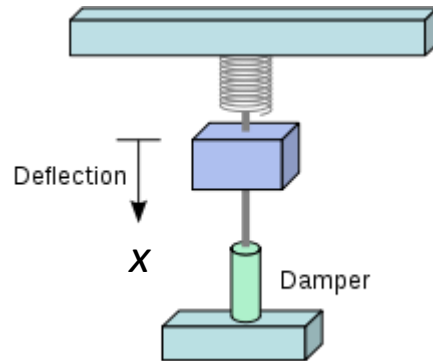
- Which means that changing the thickness t only will NOT change the natural frequency

This is bad and good together as designers have more degree of freedoms!



Damping ... Finally

- We started with a **general consideration** of **moving elements**, discussed **sensitivity related design rules** and **finally focused on the scalability ...**
- ... however, **all this cases did IGNORE damping as it happens in real situations!**



$$F = m \left(\frac{d^2 x}{dt^2} \right) + c \left(\frac{dx}{dt} \right) + kx$$

x ... displacement
 c ... damping coefficient
 k ... spring constant

- So lets consider **what happens if the damping is NOT zero ...**

Damping Quantities

- First we introduce the “**damping ratio ξ** ” which is a **dimensionless quantity describing the oscillation behaviour after an input** (e.g. sudden movement in an accelerometer)

$$\xi = \frac{c}{2m\omega_0}$$

c ... damping coefficient

m ... mass

ω_0 ... natural base frequency

- The damping coefficient is of additive character if multiple mechanism take place

$$c_{tot} = \sum_i c_i$$

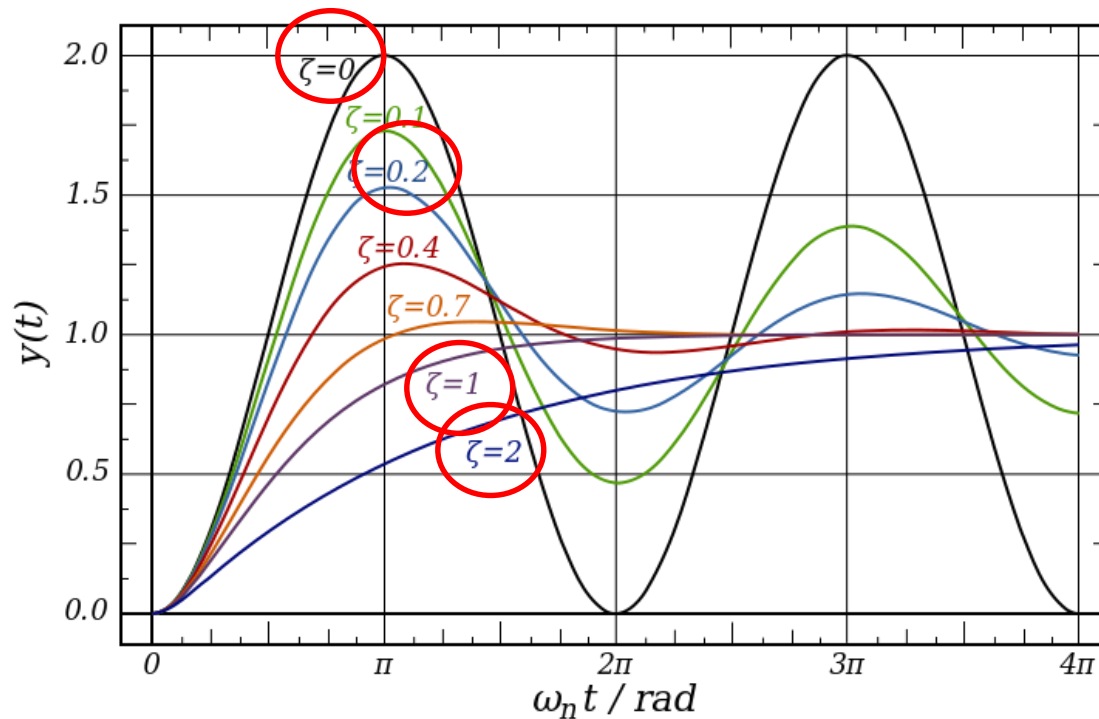
- An often found quantity of oscillating systems is the quality factor Q which relates to ξ via

$$Q = \frac{1}{2\xi} = \frac{m\omega_0}{c}$$

Damping Behaviour

ξ is a very practical quantity to describe the oscillation behaviour

- $\xi = 0 \rightarrow$ **undamped** \rightarrow ideal (unreal) case
- $\xi < 1 \rightarrow$ **underdamped** \rightarrow amplitude decays exponentially
- $\xi > 1 \rightarrow$ **overdamped** \rightarrow no further oscillations with exponential approach
- $\xi = 1 \rightarrow$ **critically damped** \rightarrow no first over-oscillation effect with fastest possible approach



$$\xi = \frac{c}{2m\omega_0}$$

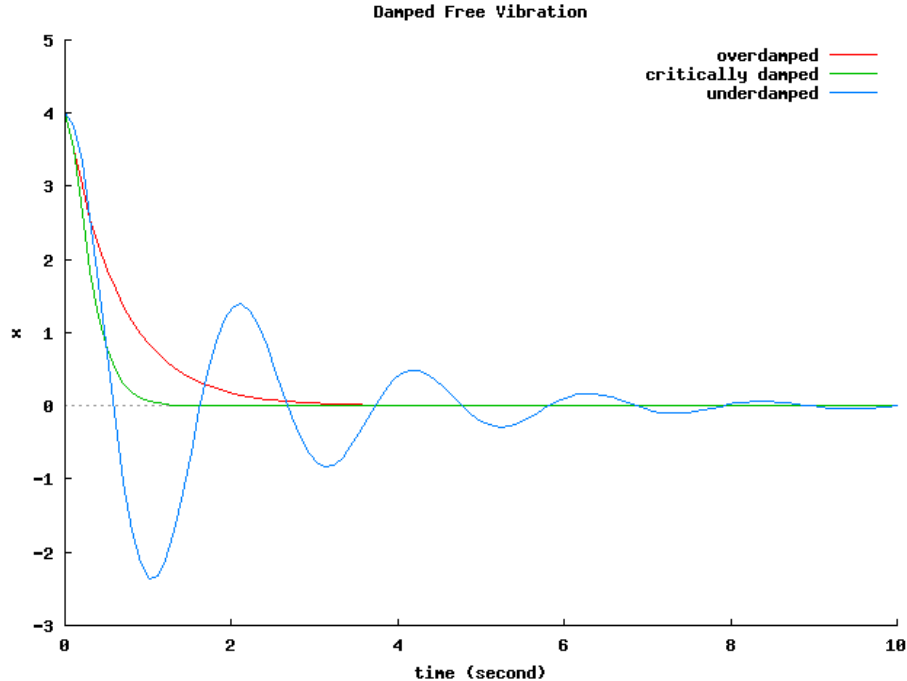
Overdamping occurs for:

- Higher damping
- Low frequencies
- Smaller masses

Damping Behaviour

ξ is a very practical quantity to describe the oscillation behaviour

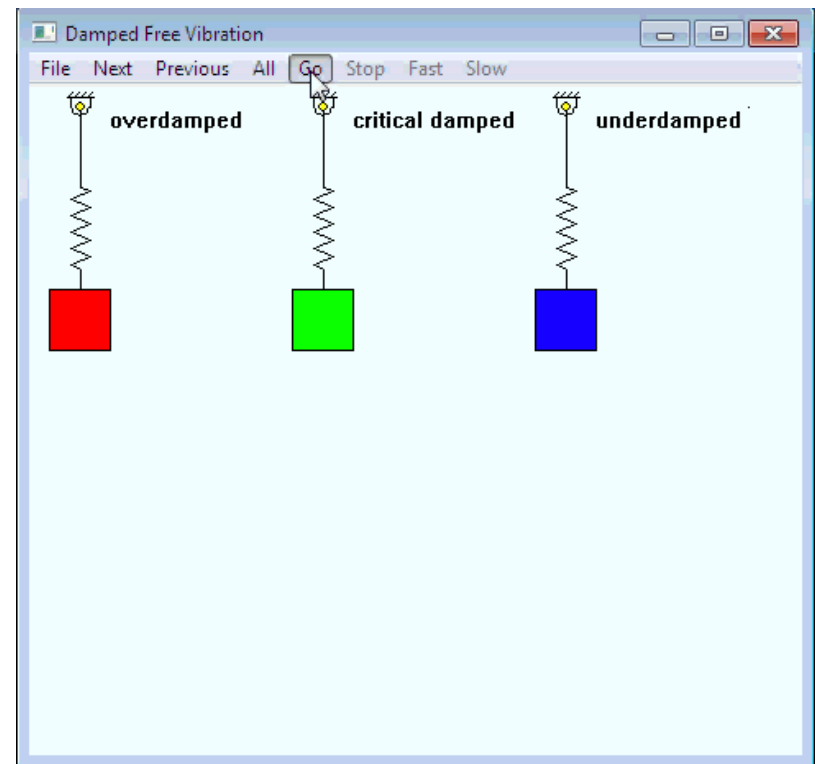
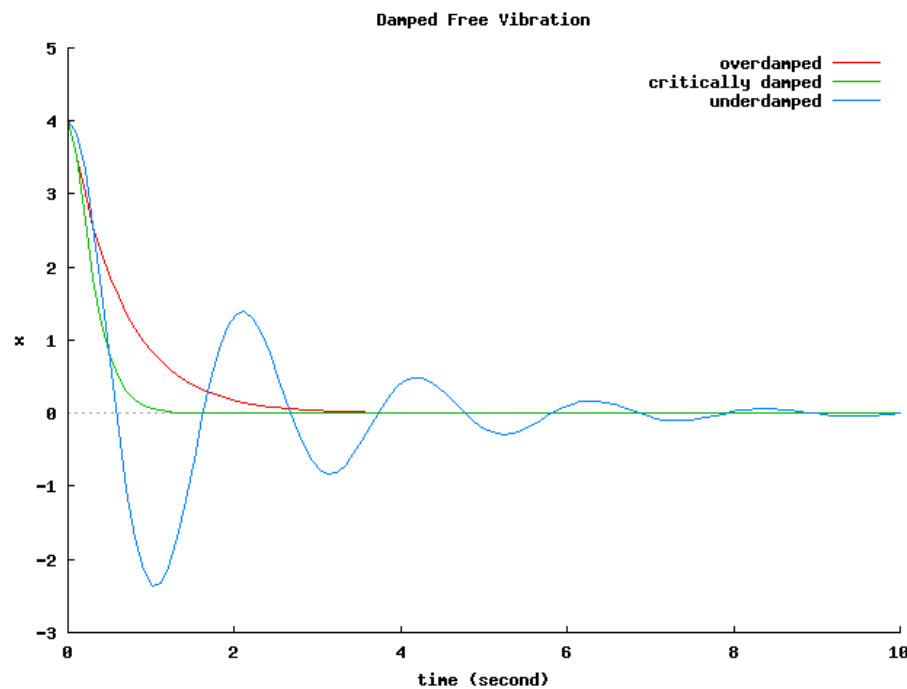
- $\xi = 0$ → **undamped** → ideal (unreal) case
- $\xi < 1$ → **underdamped** → amplitude decays exponentially
- $\xi > 1$ → **overdamped** → no further oscillations with exponential approach
- $\xi = 1$ → **critically damped** → no first over-oscillation effect with fastest possible approach



Damping Behaviour

ξ is a very practical quantity to describe the oscillation behaviour

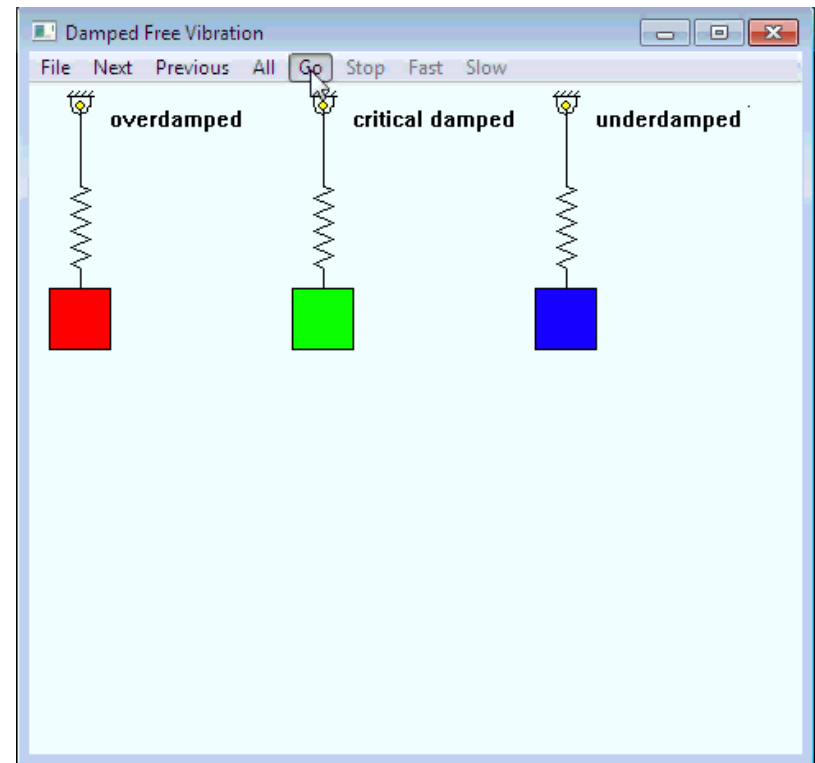
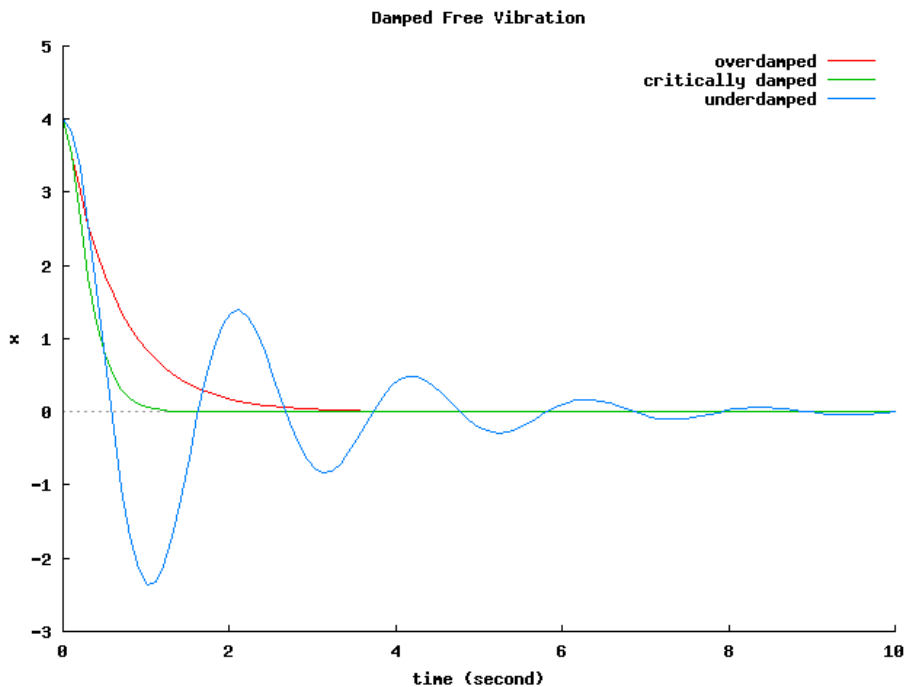
- $\xi = 0$ → **undamped** → ideal (unreal) case
- $\xi < 1$ → **underdamped** → amplitude decays exponentially
- $\xi > 1$ → **overdamped** → no further oscillations with exponential approach
- $\xi = 1$ → **critically damped** → no first over-oscillation effect with fastest possible approach



Damping Behaviour in Q Notation

In Q notation the central value is $\frac{1}{2}$ and the tendency is inverted!

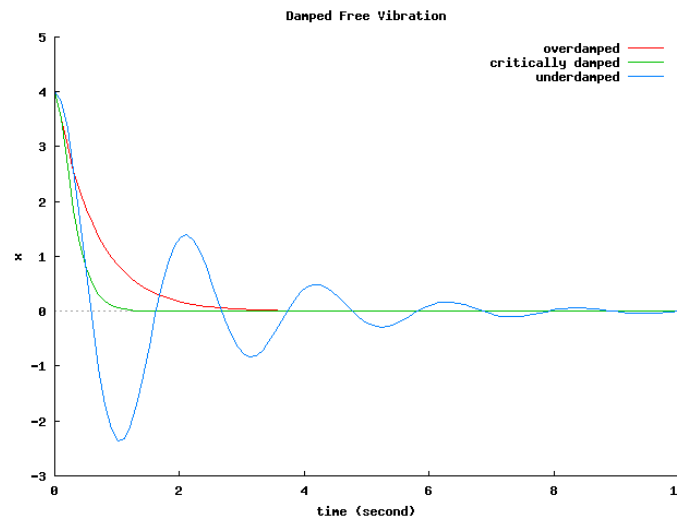
- $Q \rightarrow \infty \rightarrow$ undamped \rightarrow ideal (unreal) case
- $Q > \frac{1}{2} \rightarrow$ underdamped \rightarrow amplitude decays exponentially
- $Q < \frac{1}{2} \rightarrow$ overdamped \rightarrow no further oscillations with exponential approach
- $Q = \frac{1}{2} \rightarrow$ critically damped \rightarrow no first over-oscillation effect with fastest possible approach



Damping Sources

For applications **both oscillation regimes** can be **beneficial**

- **Accelerometers, fluid pumps, speakers** → **over damped** (no over-oscillations should appear)
- **Resonators, gyroscopes** → **under damped** (oscillation essentially required)



Next, we **need to understand the nature of damping effects** which can be classified into:

- **Intrinsic** → **material related**
- **Anchor** → **design induced**
- **Fluid / quasi-fluid** → **surrounding media related**

Although each of these effects are always evident, the dominating influence varies in dependency on the material, operation, design and environmental conditions

Damping: Intrinsic Losses

- These losses are **related to the material itself** and **mainly refers to atom / molecule movements**
- These effects, however, **often depend on the temperature** which is called **thermoelasticity**
- The **Q factor then changes** in **dependency on the frequency** (also in dependency on the mode)

$$Q = \frac{E}{\mu_\gamma \omega} = \frac{E}{\omega} \frac{1}{Ae \frac{W_A}{RT}}$$

E ... Youngs modulus

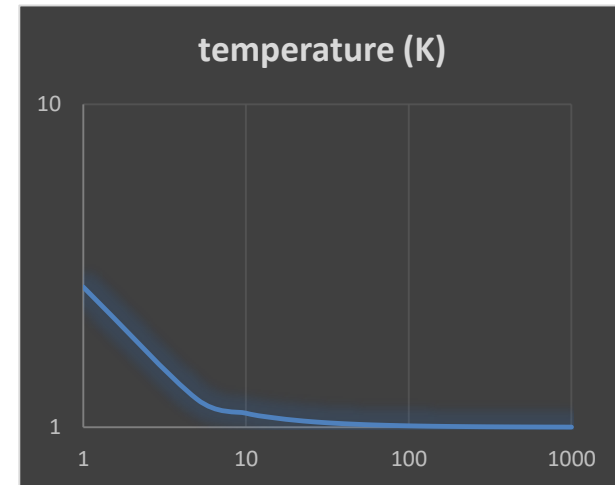
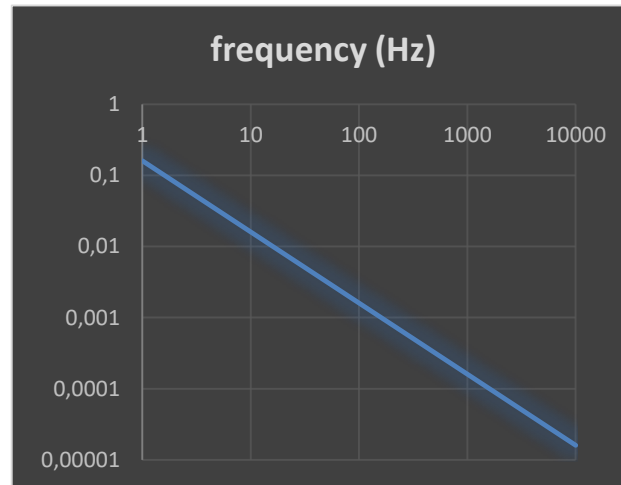
μ_γ ... material viscosity

ω ... frequency

W_A ... activation energy (splits into bond-crack energy and motion enthalpie)

R ... molar gas constant

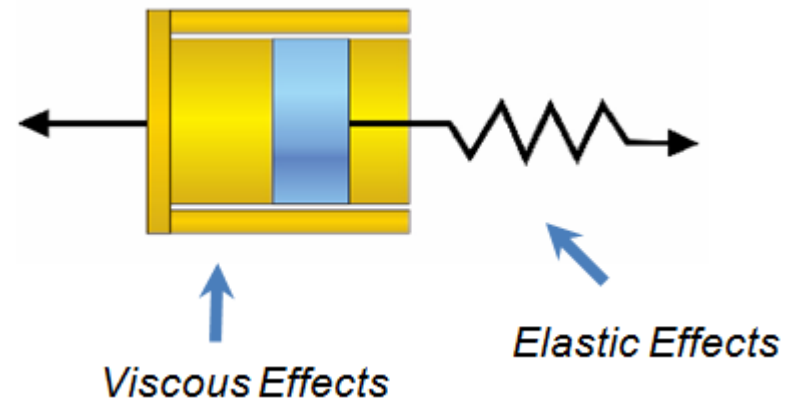
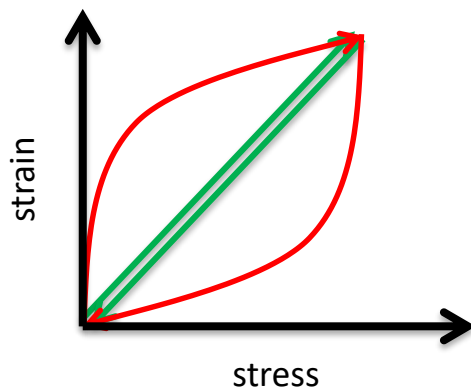
T ... temperature



- Practically spoken: **higher temperatures and higher frequencies lead to lower Q**
- This, in turn, means higher damping and less defined oscillation behaviour → lower performance

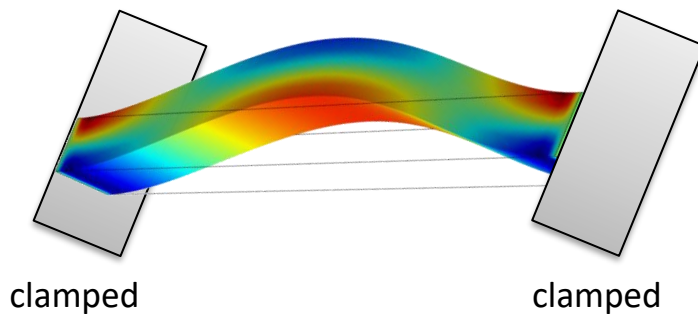
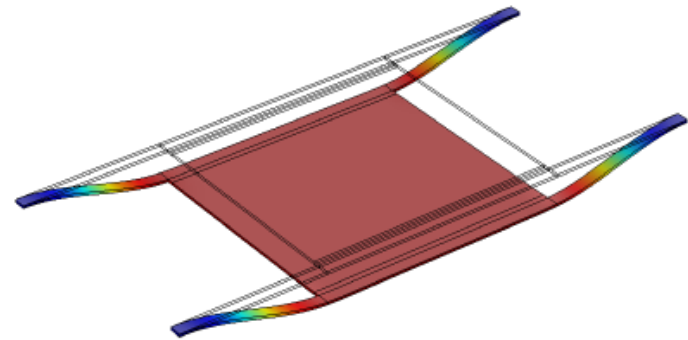
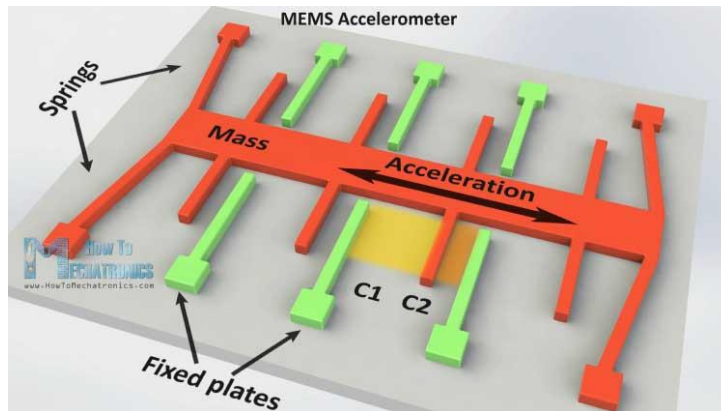
Damping: Intrinsic Losses

- Another intrinsic loss can be a **frequency and movement dependent change of mechanical properties called viscoelasticity**
- In **elastic materials** the **arising strain** due to an **applied stress is linear and reversible**
- In **viscoelastic materials**, a **pseudo-plastic trend** can be seen in both load and unload cycles but they are **still reversible**
- The effect stems from **molecular / atomic movements** and is often observed in amorphous materials and **depends on temperature, frequency and the extend of applied stress**
- **The border to real plastic deformation (irreversible) is often very small ...**

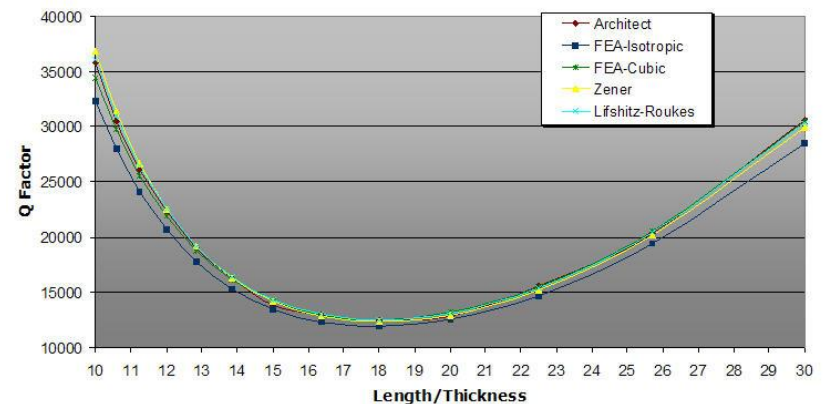


Damping: Anchor Losses

- As implied by the name, **anchor losses describe the loss of (vibration) energy by mounting**
- The losses strongly **depend on the design** (see bottom left) and result from **increased temperatures** which induce both, **general losses** (low efficiency) and also **thermoelastic effects** which **further worsen the performance**

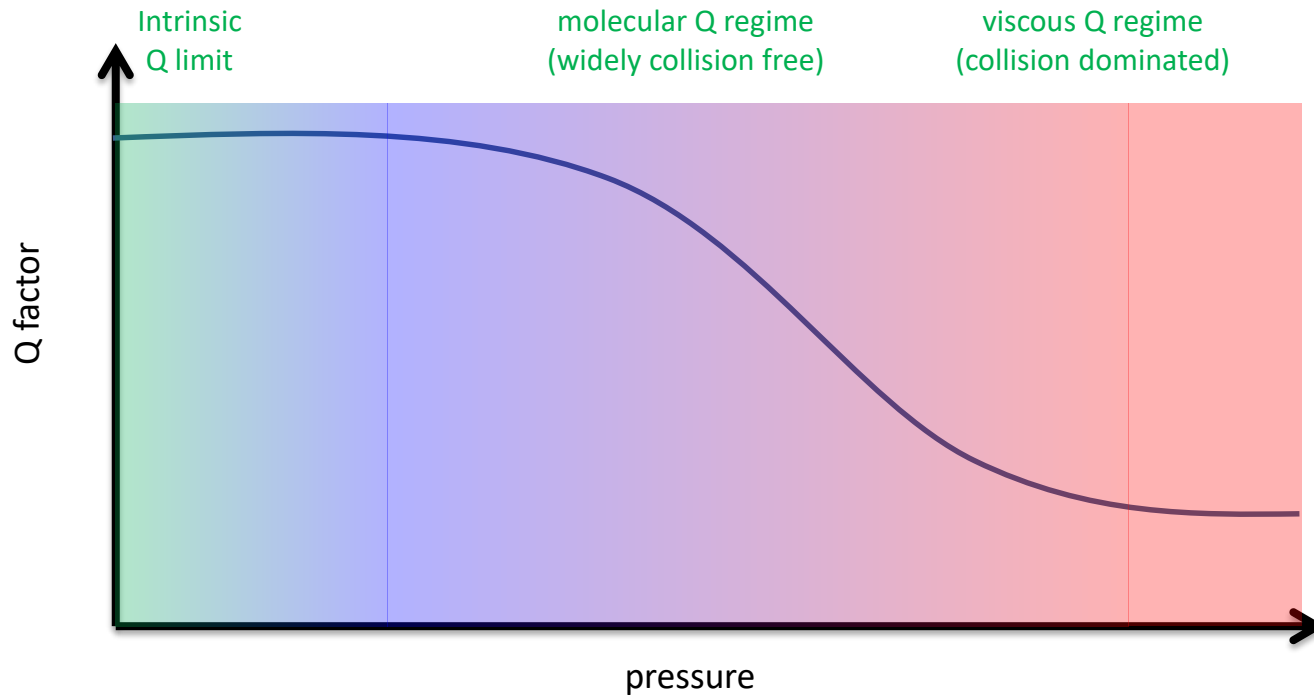


Thermoelastic Damping Q Factor Comparison



Damping: Fluid / Semi-Fluid Losses

- As long as **no media** is around a resonating element (vacuum conditions) the **Q factor** is determined by its intrinsic and anchor losses
- Once the **pressure is increasing** the regime changes
 - **Molecular** → gas molecules are considered to move on straight lines
 - **Viscous** → gas molecules undergo collisions with other gas molecules



Damping: Fluid / Semi-Fluid Losses

- For a more clear description the **Knudsen number** K_n gives is introduced

$$K_n = \frac{\lambda}{d_c} = \frac{1}{d_c} \frac{RT}{\sqrt{2}\pi d^2 p}$$

λ ... mean free path

d_c ... characteristic length

R ... universal gas constant

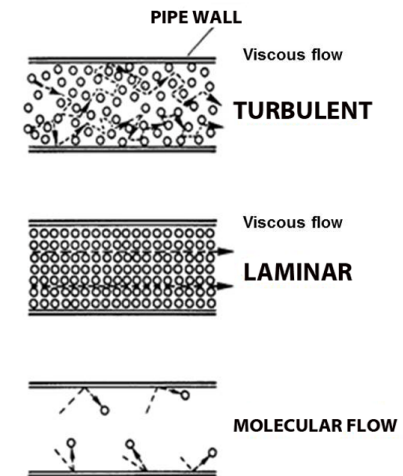
T ... temperature

d ... effective gas molecule diameter

p ... pressure

- Based on the calculated value, the **Knudsen number** K_n allows estimation of the regime:

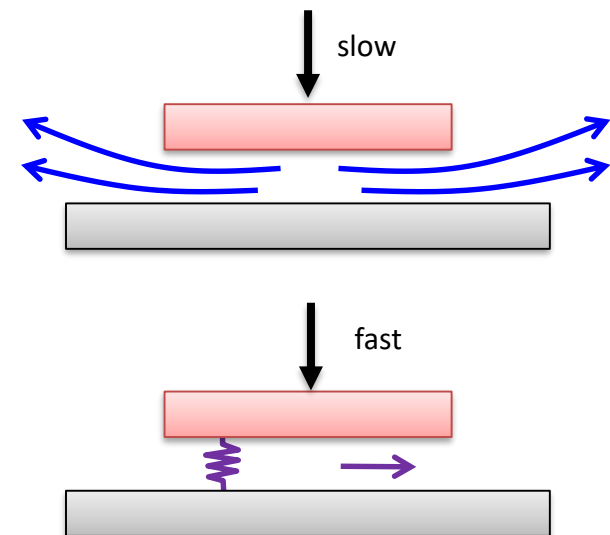
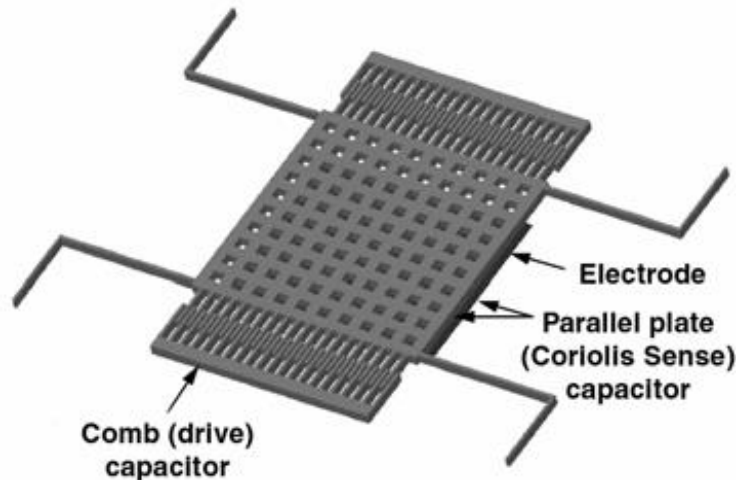
- $K_n < 0.01$ **turbulent (viscous)**
- $0.01 < K_n < 0.1$ **laminar (viscous) → gas collision dom. but collective**
- $0.1 < K_n < 2$ **Kundsen flow ($\lambda \approx d_c$) → gas / wall balanced**
- $K_n > 2$ **molecular regime → wall collision dominated**



- Most of the MEMS systems work in the Kundsen flow regime as a result of the characteristic lengths on the micro-scale

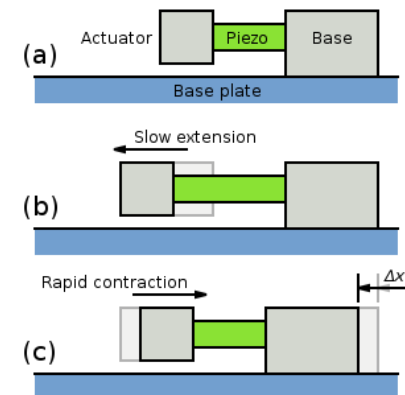
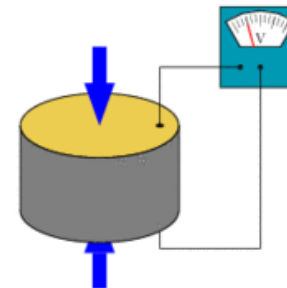
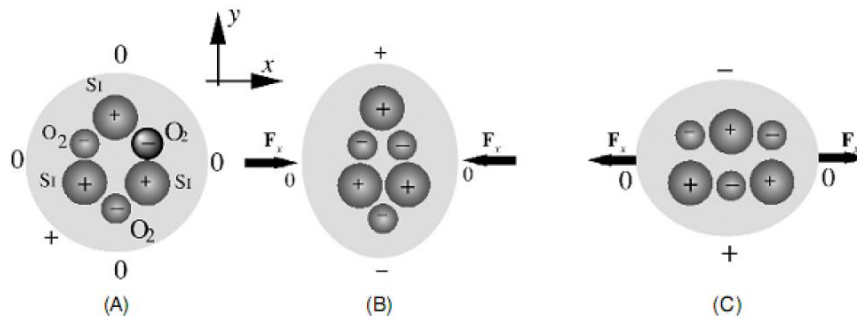
Damping: Fluid / Semi-Fluid Losses

- The **importance of these considerations** lies in the **additional environm. damping of moving parts**
- As example we consider a **3-axes accelerometer** which not only moves laterally **but also vertically**
 - **Slow Z movement** → gas is squeezed out → additional losses (c_{GAS})
 - **Fast Z movement** → gas behaves like a spring as it cannot leave fast enough ($c_{GAS} + k_{GAS}$)
- If we expand the considerations to **gyroscopes operating at high frequencies**, the **inertia effects of the gas has also to be taken into account ...**
- **Additional holes** are a very powerful method to reduce these additional losses ... but complex in calculation and design



Piezoelectric Actuation

- In principle the piezoelectric effect is the generation of electric charges due to dimensional changes (compression – expansion) for solid, crystalline materials
- The important detail is that the effect **can be used in two different ways**:
 - Applying a stress \rightarrow generation of electric charges (can be measured for sensing)
 - Applying a voltage \rightarrow dimensional change (actuation purpose)
- There are **natural** and **artificial** materials
 - Natural: **quartz (SiO_2)**, phosphate materials (e.g. Berlinite – AlPO_4), lead titanate (PbTiO_3), silk, wood (!), DNA, ...
 - Artificial: crystals (quartz analogous, Lithium tantalite - LiTaO_3 , ...), ceramics (Barium titanate - BaTiO_3 , Zinc-Oxide – ZnO , Bismuth ferrite – BiFeO_3 , ...), and some polymer (polyvinylidene fluoride - PVDF).



Piezoelectric Actuators

- We start with the equilibrium equation

$$T = Es - e\xi$$

T ... mechanical stress

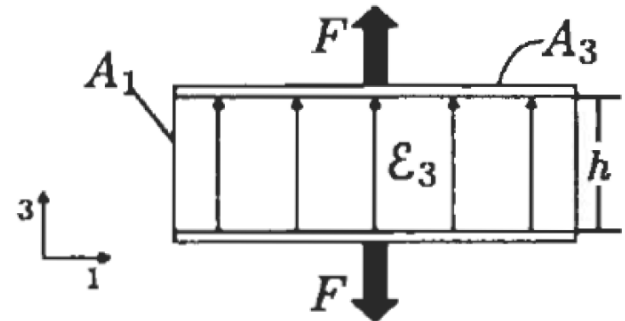
E ... Young's modulus

s ... mechanical stress

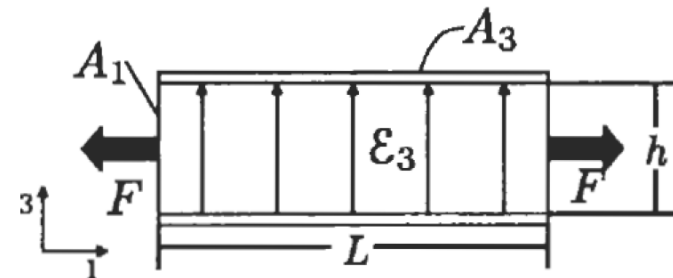
e ... piezoelectric coefficient (which is a tensor)

ξ ... electric field

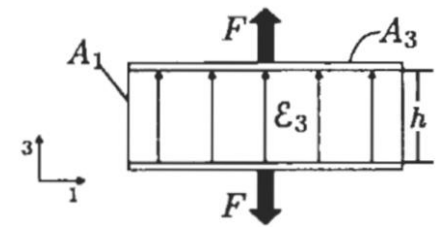
- Longitudinal** → force parallel to electric field



- Transverse** → force perpendicular to electric field



Piezoelectric Actuators



- Now we index the quantities in accordance to the relevant directions (E field and movement)

$$T_3 = E s_3 - e_{33} \xi_3$$

- If no mechanical constraints are given (spatially free deformation) we can use $T_3 = 0$ which gives

$$s_3 = \frac{e_{33}}{E} \xi_3 \rightarrow \text{with } U = \xi h \text{ it follows } \rightarrow s_3 = \frac{e_{33}}{E} \frac{U}{h}$$

- Now rewriting the mechanical stress into $s_3 = \frac{\Delta h}{h}$ we obtain

$$\Delta h = \frac{e_{33} h U}{E h} = \frac{e_{33}}{E} U$$

- Which gives the displacement Δh in dependency on the material parameters e (piezoelectric coefficient) and the Youngs modulus E and the operation voltage U

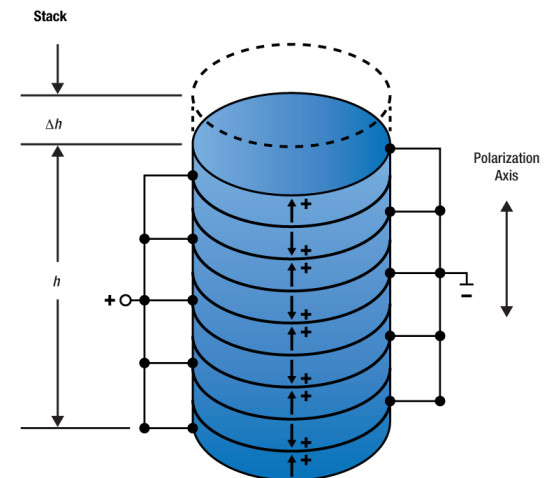
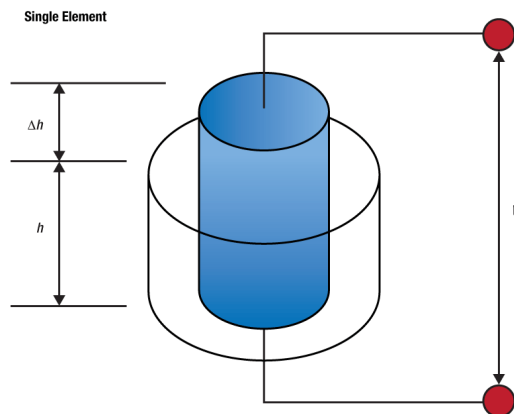
Piezoelectric Actuators

- The **important finding**, however, is the fact that the displacement is **independent on the actuator dimension** (only the piezoelectric coefficient e_{ij} is of relevance from the material side)

$$\Delta h = \frac{e_{ii}}{E} U$$

- The **only way to increase the absolute movements** is to **increase the operation voltage** (not always applicable) and the **application of multiple stacks N** :

$$\Delta h_{tot} = N \frac{e_{ii}}{E} U$$

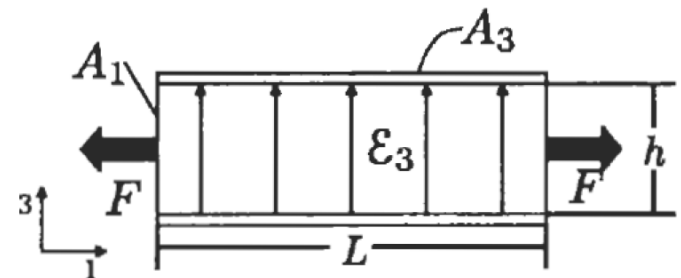
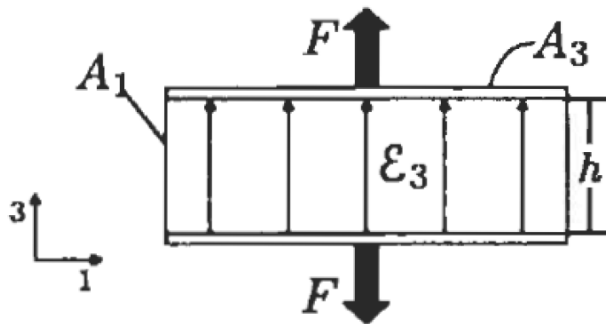


Piezoelectric Actuators

- Another degree of freedom is the **different design** by means of **longitudinal and transverse**
- The formalism changes slightly into:

	Longitudinal	Transverse
F_{piezo}	$F_{\text{piezo}} = \frac{e_{33}A_3}{h} v$	$F_{\text{piezo}} = \frac{e_{31}A_1}{h} v$
Displacement (Δh)	$\Delta h = \frac{e_{33}}{E} v$	$\Delta L = \frac{e_{33}L}{E h} v$

- A evident, there is a **size dependency of ΔL on L** in the **transverse** case as well as a **thickness dependency!** Here the design is slightly more flexible!



Piezoelectric Actuators – Smart Design

- Smart design then allows for spatially controlled movements 😊



